505797998 12/02/2019

PATENT ASSIGNMENT COVER SHEET

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UBMISSION TYPE:		N	NEW ASSIGNMENT				
ATURE OF CONVEYANCE:		A	ASSIGNMENT				
CONVEYING PARTY	DATA						
		Na	ame			Execution Da	
ATHAR ALI KHAN. P						02/25/2019	
MANISH KUMAR VIS	WKARMA					02/25/2019	
RECEIVING PARTY	ΟΑΤΑ						
Name:	SEMIC	ONDUC	TOR COMPONENTS	INDUST	RIES, L	LC	
Street Address:	5005 E	5005 E. MCDOWELL ROAD					
Internal Address:	MAILD	MAILDROP A700					
City:	PHOEN	PHOENIX					
State/Country:	ARIZO	ARIZONA					
Postal Code:	85008	85008					
Property Typ Application Number:		167000	Number 28]		
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ASSIGNMENT & AGREEMENT ONS02931US

For good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, we,

Name	of (City and State OR Country)
ATHAR ALI KHAN. P	KANAKA NAGAR INDIA
MANISH KUMAR VISWKARMA	BANGALORE INDIA

agree to sell, assign, and transfer, and do hereby sell, assign, and transfer to Semiconductor Components Industries, LLC, a limited liability company of the State of Delaware, having its principal office in Phoenix, State of Arizona, United States of America, and its successors, assigns, and legal representatives ("SCI"), the entire right, title, and interest in and to the inventions and discoveries as described, illustrated, and/or claimed in

Title: METHODS AND APPARATUS FOR AN INTERFACE

Attorney Docket No.: ONS02931US

Serial No.: 16/283951

Filing Date: February 25, 2019

together with the entire right, title, and interest in and to the above listed application(s), and in and to any and all provisional, non-provisional, divisional, continuation, continuation-in-part, international, foreign, and any and all other applications related thereto, and also including any and all grants, issuances, letters patent, relssues, reexaminations, renewals, priority rights, and priority claims related to any of the foregoing, and any and all rights to collect past damages for infringement of any of the foregoing (the "Patent Rights").

We further authorize SCI to apply for and hold and maintain the Patent Rights throughout the world directly in its own name or any other name which SCI deems appropriate in its sole discretion, and to claim the priority of the filing date of the above listed application(s).

We agree that, when requested, we will, without charge to SCI, sign all papers, take all rightful oaths, and do all acts which may be necessary, desirable, or convenient for securing, maintaining, and enforcing the Patent Rights in any and all countries and for vesting title thereto in SCI or its nominees.

We represent and warrant that we have full right to convey the entire right, title and interest herein sold, assigned, and transferred, and that the Patent Rights hereby conveyed are free from all prior assignment, grant, mortgage, license, or other encumbrance to anyone other than SCI. We covenant and further warrant that we will not convey hereafter any part of the Patent Rights to anyone other than SCI or do any act whatsoever conflicting with this ASSIGNMENT & AGREEMENT.

We hereby authorize SCI or anyone it may properly designate to insert in this ASSIGNMENT & AGREEMENT the filing date and serial number of the above listed application(s) when ascertained. More than one counterpart of this ASSIGNMENT & AGREEMENT may be executed, each of which will be deemed an original.

Page 1 of 2

PATENT REEL: 051149 FRAME: 0459

ASSIGNMENT & AGREEMENT ON502931US

By (Inventor signature):	Ach	ou Ali	them	· P
	ar Ali Ki			
Witnessed by (Witness signat	ure):	<u>Pla</u>	nduy	
Printed name of Witness:		RAJIV	PANI	> 64
Signed and Witnessed on this		day of		, 2019 Vear
	day	mo	nth	year

	12.0.	
Witnessed by (Witness signature):	(Clard	8.34
Printed name of Witness:	RAJIV	PANDEY

PATENT REEL: 051149 FRAME: 0460

Page 2 of 2

RECORDED: 12/02/2019